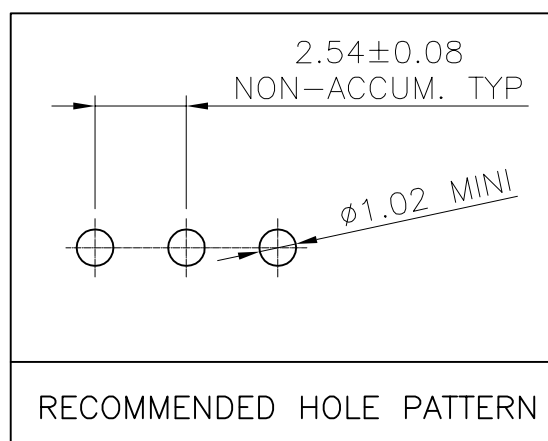
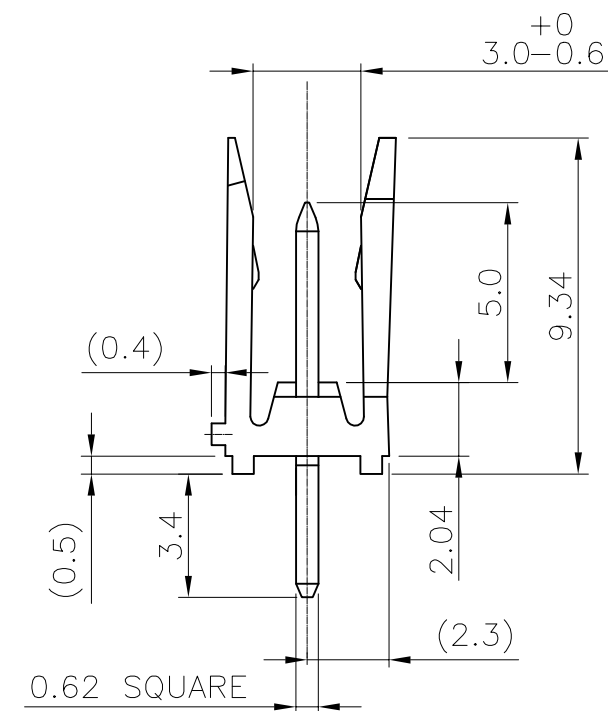
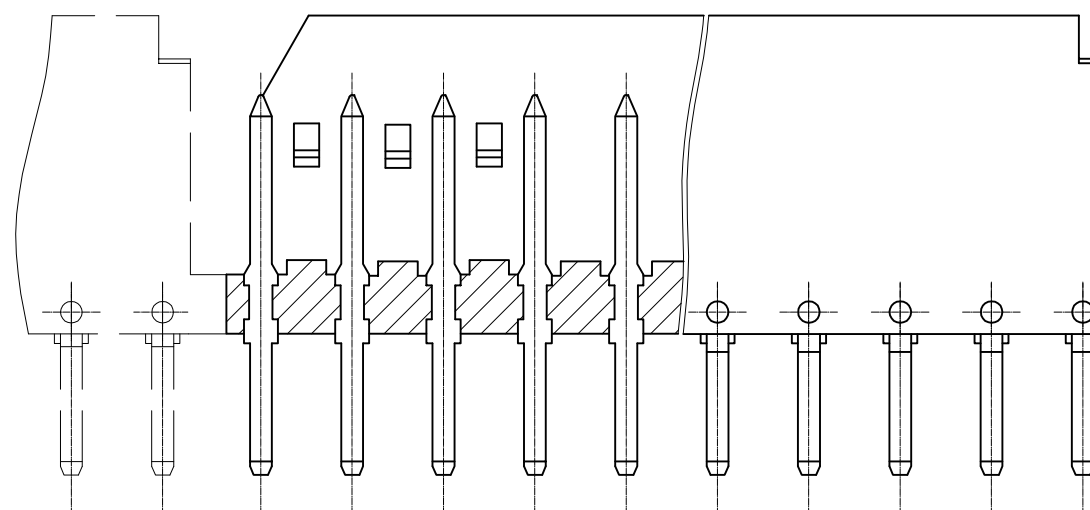
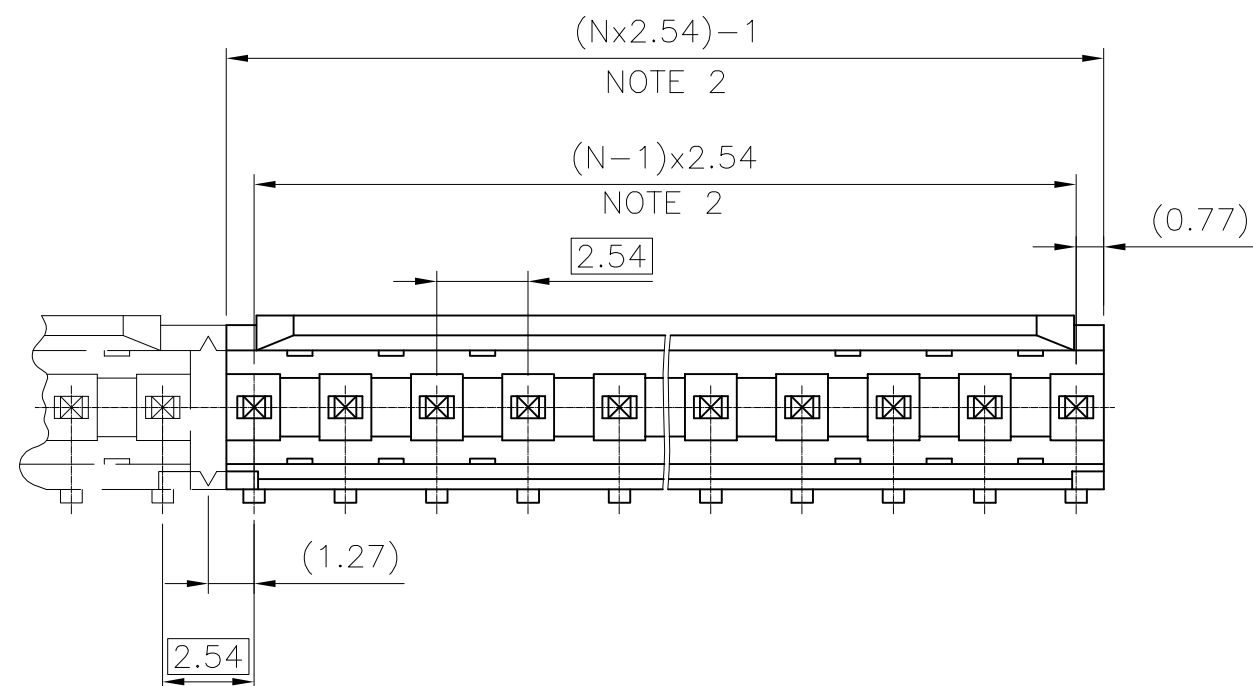


PRODUCT NUMBER
SEE SHEET 2

NOTES :

1. MINI PUSH-OUT FORCE TERMINAL IN BOTH DIRECTIONS 22N.
2. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
EXAMPLE: 8 POS: $(N \times 2.54) - 1 = 19.32$ mm



mat'l. code SEE NOTES				surface ISO 1302 ✓		tolerance ISO 406 ISO 1101		projection 		product family DUBOX						
ltr	ecn no	dr	date	tolerances unless otherwise specified						title SHR. HEADER STR SR TMT						
N	F06-0228	LMU	06.07.11	angles	linear	.X ±0.3		scale 5:1								
P	F06-0319	LMU	06.11.10			.XX ±0.15										
R	F07-0147	LMU	07.03.01			.XXX ±0.05										
S	F07-0220	J.CO	07.06.14	dr	D LEGRAND		99.03.03				dwg no		sheet 1 of 2		size	
T	F08-0147	YOV	08.04.14	engr	JM PHAMVAN		99.03.03				76384				A	
				chr	JM PHAMVAN		99.03.03									
M	F05-0159	LMU	05.03.31	appd	JM PHAMVAN		99.03.03				type		CUSTOMER Drawing			
sheet index		revision		T	E											
		sheet		1	2											

76384-YXX

3= 0.76μm GOLD/GXT ON CONTACT AREA.
3.81μm TIN-LEAD ON TAIL OVER 1.27μm Ni MIN.

4= 3.81μm TIN LEAD OVER 1.27μm Ni MIN

- 1 - HOUSING MAT'L: THERMOPLASTIC GLASS FILLED
FLAME RETARDANT PER UL 94 V-O COLOR: BLUE.
- 2 - TERMINAL MATERIAL: COPPER ALLOY.
- 3 - 2 UP TO 6 POSITIONS, PRODUCT PACKED IN PLASTIC BAG.
7 UP TO 18 POSITIONS, PRODUCT PACKED IN TUBE.
- 4 - ONLY DASH NUMBER -X02 AND -X03
ALWAYS TEN (10) PRODUCTS MOLDED ASSEMBLY
& DELIVERY TOGETHER ACCORDING PHANTOM LINES.

76384-YXXLF

3= 0.76 μ m GOLD/GXT ON CONTACT AREA.
2 μ m MIN MATTE TIN ON TAIL.
OVER 1.27 μ m Ni MIN

SUFFIX LETTER "LF" INDICATES THE PRODUCT IS RoHS COMPLIANT, SEE NOTE 5

- NUMBER OF POSITIONS: 02 TO 18

- 1 - HOUSING MAT'L: THERMOPLASTIC GLASS FILLED
FLAME RETARDANT PER UL 94 V-O COLOR: BLACK.
- 2 - TERMINAL MATERIAL: COPPER ALLOY.
- 3 - 2 UP TO 6 POSITIONS, PRODUCT PACKED IN PLASTIC BAG.
7 UP TO 18 POSITIONS, PRODUCT PACKED IN TUBE.
- 4 - ONLY DASH NUMBER -X02 AND -X03
ALWAYS TEN (10) PRODUCTS MOLDED ASSEMBLY
& DELIVERED ON STRIP ACCORDING PHANTOM LINES.

- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2μm MINIMUM MATTE TIN OVER 1.27μm MINIMUM NICKEL UNDERPLATE.

- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

– MEETS PACKAGING SPECS AS PER GS-14-920

d - LEGAL STATEMENT: SEE GS-22-008

mat'l. code SEE NOTES				surface ISO 1302 ✓ tolerance ISO 406 ISO 1101			projection 		product family DUBOX				
ltr	ecn no	dr	date	tolerances unless otherwise specified				title SHR. HEADER STR SR TMT					
A	F05-0159	LMU	05.03.31	angles	linear	.X	±0.3						
B	F06-0228	LMU	06.07.11			.XX	±0.15						
C	F07-0147	LMU	07.03.01			.XXX	±0.05						
D	F07-0220	JCO	07.06.14	dr	L.MULIN	05.03.25			dwg no		sheet 2 of	size	
E	F08-0147	YOV	08.04.14	engr	J.COMPAGNON	05.03.25			76384		A3		
				chr									
				appd	JM.C	05.03.25			type CUSTOMER Drawing				
sheet index		revision sheet											